	TRANSMITTAL FORM (Expe used for all correspondence after initial filing)			Application Number		09/844,293	
E JC,				Filing Date		April 26, 2001	
				First Named Inventor		Bothra, Subhas	
~~`				Art Un	it	2826	
W. A.				Exami	ner Name	Alexander O. Williams	
PATENT BY	Total Number of Page Submission	es in This		Attorn	ey Docket Number	020408-001200US	
))					
	Fee Transmittal Form		☑ Drawing(s)		S (Check all that appl	After Allowance Communication to Group	
	Fee Attached		Licensing-related Papers		ed Papers	Appeal Communication to Board of Appeals and Interferences	
	Amendment/Reply		Petition			Appeal Communication to Group (Appeal Notice, Brief, Reply Brief)	
	After Final		Petition to Convert to a Provisional Application			Proprietary Information	
-	Affidavits/declaration(s)		Power of Attorney, Revocation Change of Correspondence Address			Status Letter	
	Extension of Time Request		Terminal Disclaimer		imer	Other Enclosure(s) (please identify below):	
e .	Express Abandonment Request		Request for Refund CD, Number of CD(s)			PTO-85B Issue Fee Transmittal Letter to Official Draftsperson Return Postcard	
•	☐ Information Disclosure Statement						
•	Certified Copy of Priority Document(s)		Remarks The Commissioner is a Account 20-1430.			authorized to charge any additional fees to Deposit	
	Response to Mis						
1	Response to Missing Parts under 37 CFR 1.52 or 1.53 SIGNATURE OF APPLICANT, ATTORNEY, OR AGENT						
•							
. *	Firm Townsend and Townsend and Crew LLP						
	Individual Chun-Pok Leung Reg. No. 41,405						
	Signature C L 6U						
	Date (2 – (% – 6)						
	CERTIFICATE OF TRANSMISSION/MAILING						
	I hereby certify that this correspondence is being facsimile transmitted to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below.						
	Typed or printed nam	e Andrea S/B	eck				
	Signature	A				Date 10/03	
				`	<u>_</u>		

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I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to:

PATENT Attorney Docket No.: 020408-

001200US



Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

on <u>December 10, 200</u>

TOWNSEND and TOWNSEND and CREW LLP

Andrea S. Beck

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Subhas Bothra, et al.

Application No.: 09/844,293

Filed: April 26, 2001

For: Structure to Increase Density of

MIM Capacitors Between Adjacent

Metal Layers in a Integrated

Circuit

Confirmation No: 1043

Examiner: Alexander O. Williams

Art Unit: 2826

LETTER TO OFFICIAL DRAFTSPERSON

Mail Stop Issue Fee Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Notice of Allowance dated October 3, 2003, applicants hereby submit 7 sheets of formal drawings to be made of record in the above-identified case.

Respectfully submitted,

Chun-Pok Leung Reg. No. 41,405

TOWNSEND and TOWNSEND and CREW LLP Two Embarcadero Center, 8th Floor San Francisco, CA 94111 (650) 326-2400 Fax (650) 326-2422